Substitute Form PTO-1449 (Modified)

U.S. Department of Commerce Patent and Trademark Office Attorney's Docket No. 12406-109US1

Application No. 2,2,5 18

Information Disclosure Statement by Applicant

(Use several sheets if necessary)

Applicant Stefan Groetsch

Filing Date Herewith

Group Art Unit

(37 CFR §1.98(b))

U.S. Patent Documents							
Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
A	AA	5,105,430	04/14/1992	Mundinger et al.			
Z	AB	5,373,731	12/20/1994	Tanaka, et al.			
L	AC	5,812,570	09/22/1998	Spaeth			
1	· AD	5,903,583	05/11/1999	Ullman <i>et al.</i>			
A	AE	US2002/0063 329	05/30/2002	Horie et al.			
K	AF	US2003/0099 267	0529/2003	Henning et al.			
	AG						
	AH						
	Al						
	AJ						
	AK						·

	Foreig	n Patent Doo	cuments or P	ublished Forei	gn Pate	nt Applic	ations	
Examiner	Desig.	Document	Publication	Country or			Translation	1
Initial	ID	Number	Date	Patent Office	Class	Subclass	Yes	No
AL	AL	DE 4315580	11/17/1993	Germany			Abstract	
1	AM	DE 4335512	06/01/1995	Germany			Abstract	
	AN	DE 19605302	02/14/1996	Germany			Abstract	
	AO	DE 19506093	08/29/1996	Germany	,		Equivalent to 5,903,583	
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	AR	EP 0 509825	10/21/1992	Europe			Yes	-2-
*	AS	EP 0 771604	05/07/1997	Europe			Equivalent to 5,373,731	
M	AT	WO 97/30494	08/21/1997	WIPO			Abstract	

Other Documents (include Author, Title, Date, and Place of Publication)					
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Initial	D	Document			
Examiner Sign	4-KM	103/12 Date Considered 6-24-07			
EXAMINER: I next communi	nitiais citatio	icant.			
		Substitute Disclosure Form (PTO-1449)			

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U.S. Department of Commerce Patent and Trademark Office

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(Use several sheets if necessary)

(Use Statement Stefan Groetsch

Filing Date Group Art Unit

Herewith

Examiner	Desig.	
Initial	ID	Document
	AU	Johnson, WB. et al., "Diamond/Al Metal Matrix Composites Formed by the Pressureless Metal Infiltration Process", J. Mater. Res., Vol. 8, No. 5, pp. 1169-1173, XP-002304359, 1993
N	AV	Kerns, JA. Et al., "Dymalloy: A Composite Substrate for High power Density Electronic Components", <i>The International Journal of Microcircuits and Electronic Packaging</i> , Vol. 19, no. 3 XP 000639483, 1996.
K	AW	Sun, Q. and Inal, QT., "Fabrication and Characterization of Diamond/Copper Composites for Thermal Management Substrate Applications", <i>Materials Science and Engineering</i> . B41, pp. 261-266, 1996.
	AX	

Examiner Signature A Rolling	Date Considered $6-24 \rightarrow 7$
EXAMINER: Initials citation considered. Down line through citation if no next communication to applicant.	t in conformance and not considered. Include copy of this form with